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**History of MEMS**

**Knowledge Probe (Pre-Quiz)**

**Instructor Guide**

**Note to Instructor**

This unit assesses the learner's current knowledge of MEMS history prior to completing the History of MEMS Learning Module. There are 15 assessment questions.

The *History of MEMS Learning Module* consists of the following.

* **History of MEMS Knowledge Probe (Pre-Quiz)**
* History of MEMS Primary Knowledge
* History of MEMS Activity
* History of MEMS Final Assessment

This companion Instructor Guide (IG) contains both the questions and answers for the assessment questions.

**Introduction**

*This learning module provides a timeline of the progression of microtechnology through a series of innovations that starts with the first Point Contact Transistor built in 1947 and ends with the optical network switch in 1999.  Activities provide the opportunity to build on this timeline and to identify innovations of the 21st century that have contributed to current advancements in both micro and nanotechnology*.

This Knowledge Probe (pre-quiz) helps to identify your current knowledge of the history of MEMS prior to completing the History of MEMS Learning Module and its related activities. Answer the following questions to the best of your knowledge.

There are 15 questions.

1. Which of the following events is associated with Dr. Richard Feyman?
   1. Invention of the germanium transistor
   2. “There’s Plenty of Room at the Bottom” speech
   3. Resonant gate transistor patent
   4. Design of the integrated pressure sensor
2. The 1954 discovery of the piezoresistive effect in silicon made which of the following possible?
   1. Polysilicon structures as electronic components
   2. Polysilicon structural layers as insulating layers
   3. Silicon substrates as thermoelectric components
   4. Bulk etching into silicon substrates
3. The following MEMS structure was manufactured using which of these micromachining processes?
   1. Surface
   2. Bulk
   3. LIGA
   4. SCREAM



1. The invention of the \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ in 1986 allowed us to “see” the topography of an atomic structure.
   1. The microscope
   2. Scanning electron microscope
   3. Tunneling microscope
   4. Atomic Force microscope
2. HP micromachined the first \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ in 1979, a device used in both commercial and personal products.
   1. Resonant gate transistor
   2. Ink-jet nozzle
   3. Crash or inertial sensor
   4. Electrostatic drive motors
3. In 1958, one of the first \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ was built by Jack Kilby from Texas Instruments and it consisted of one transistor, three resistors, and one capacitor.
   1. Resonant gate transistor
   2. Crash or inertial sensor
   3. Integrated circuit
   4. Electrostatic sensor
4. Dr. Feynman felt that lubrication would most likely NOT be an issue for components in the micro-scale due to \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ in the micro-scale.
   1. minimal force and rapid heat loss
   2. the types of forces
   3. the interactive forces
   4. the lack of inertia and friction
5. Which of the following is NOT a micromachining method?
   1. Bulk
   2. Surface
   3. MOEMS
   4. LIGA
6. Which of the following was the first batch fabricated MEMS device?
   1. Inkjet nozzle
   2. Resonant gate transistor
   3. Optical switch
   4. Integrated circuit
7. Van der Waals attraction is the attraction between
   1. Molecules and atoms
   2. Atoms and surfaces
   3. Molecules and surfaces
   4. Molecules, atoms and surfaces
8. Which of the following challenges was NOT made by Dr. Feynman to encourage the exploration of “small” technology?
   1. Putting the information from a page of a book on an area 1/25,000 smaller in linear scale
   2. Fabricating an internal combustion engine that would fit on the head of a pin
   3. Making an operating electric motor which fits inside a 1/64 inch cube
9. Electrochemical anisotropic etching is important in microsystems fabrication because it is the basis of the \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ micromachining process.
   1. Bulk
   2. Surface
   3. MOEMS
   4. LIGA
10. The micromachining process that allows for the fabrication of high aspect ratio devices as high as 100:1, is called
    1. Bulk
    2. Surface
    3. MOEMS
    4. LIGA
11. In 1994, Bosch, a German company, developed the “Bosch process” that is used in \_\_\_\_\_\_\_\_\_\_\_ processes.
    1. Bulk
    2. Isotropic
    3. RIE
    4. DRIE
12. In 1999 Lucent Technologies developed the first micro-sized \_\_\_\_\_\_\_\_\_\_\_\_\_ enabling the advancement of data communication.
    1. Integrated mechanical switch
    2. Resonant gate switch
    3. Optical network switch
    4. Electrostatic network switch

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